

Last slide of my presentation at this workshop on February 7, 2006:

Conclusions

- Once very fashionable, the area of GB diffusion is not hot anymore. It is not considered to be cool enough. It cannot compete with carbon nanotubes and quantum dots
- It is only the Herzig group in Muenster that keeps GB diffusion measurements alive
- Development of GB diffusion theory stopped (June 1, 2005)
- Posterity will not forgive us



Grain boundary diffusion The rest of the story

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Outline

- Quick overview of the field
- Diffusion along grain boundaries and their triple junctions in copper
- Diffusion along low-angle grain boundaries in aluminum



Importance of GB diffusion

GB diffusion is much faster than lattice diffusion (E.g. $D_{gb}/D_L \approx 10^{10}$ at $0.5T_m$ in fcc metals)



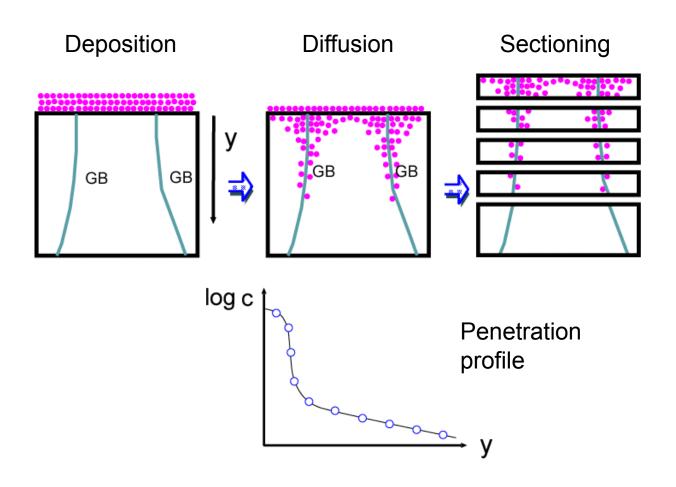
<u>Processes controlled/influenced by GB diffusion</u>:

- Solid state reactions (discontinuous precipitation,...)
- Grain growth
- Deformation and fracture at elevated temperatures
- Coble creep
- GB dislocation climb
- Structural relaxation after fabrication (severe plastic deformation, etc.)

Diffusion is a structure-sensitive property

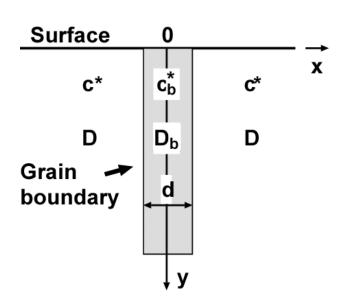


Radiotracer sectioning method



Need many GBs to achieve a high accuracy

Fisher model of GB diffusion



$$\frac{\partial c^*}{\partial t} = D \left(\frac{\partial^2 c^*}{\partial x^2} + \frac{\partial^2 c^*}{\partial y^2} \right)$$

$$\frac{\partial c_b^*}{\partial t} = D_b \frac{\partial^2 c^*}{\partial y^2} + \frac{2D}{\delta} \left(\frac{\partial c^*}{\partial x} \right)_{x=\delta/2}$$

Coupling conditions:

Self-diffusion $A^* \rightarrow A$: $c_b^* = c^*$

Impurity diffusion $B^* \rightarrow A$: $c_b^* = sc^*$, where $s = s_0 exp(-E_s/kT)$

Self-diffusion in alloy B* \rightarrow A-B: $c_b^*=sc^*$, where $s=c_b^B/c^B$

Solution of the Fisher model

Under typical experimental conditions

$$\log \overline{c} \propto -\left[\frac{4\pi D}{\left(s\delta D_b\right)^2}\right]^{3/10} y^{6/5}$$



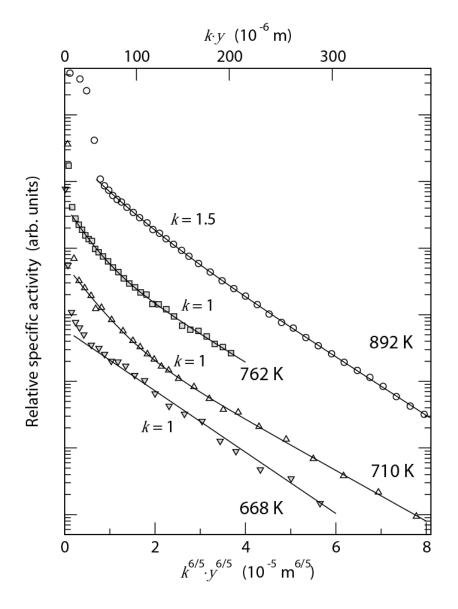
$$s\delta D_b = q \left(\frac{D}{t}\right)^{1/2} \left(-\frac{\partial \ln \overline{c}}{\partial y^{6/5}}\right)^{-5/3}$$

q – numerical factor depending on the surface condition

- Assume $\delta = 0.5 \text{ nm}$
- Must know D from independent measurements



Examples of GB diffusion profiles



Ag in Cu-0.2at%Ag

Divinski et al., *Interface Science* **11**, 21 (2003)

Combined B and C regime measurements

Regime B (high temperatures)

$$(Dt)^{1/2} >> s\delta \implies \overline{c}(y, s\delta D_b) \implies s\delta D_b$$

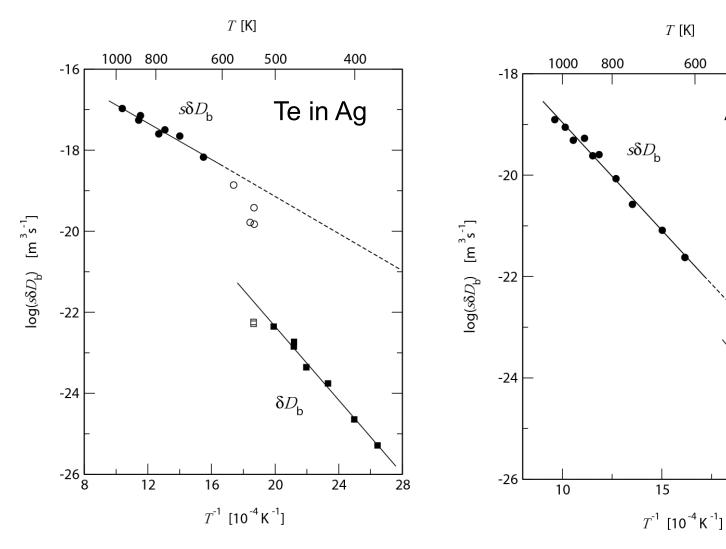
Regime C (low temperatures – extremely difficult measurements!)

$$(Dt)^{1/2} << s\delta \implies \overline{c} \propto \exp\left(-\frac{y^2}{4D_b t}\right) \implies D_b$$

$$s\delta = \frac{(s\delta D_b)_B}{(D_b)_C}$$

Self-diffusion: $s = 1 \Rightarrow \delta \approx 0.5$ nm (Atkinson and Taylor 1981; Sommer and Herzig 1992; Gas, Beke and Bernardini 1992)

Example of combined B and C regime measurements



C. Herzig et al., *Acta Mater.* **41**, 1683 (1993)

T. Surholt et al., *Phys. Rev. B.* **50**, 3577 (1994)

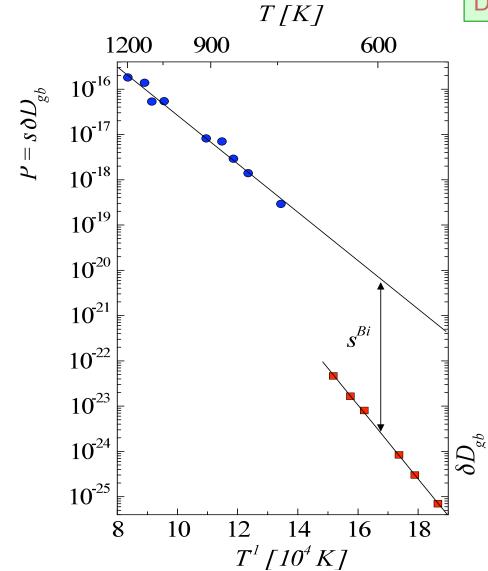
500

 $\delta D_{\rm b}$

20

Au in Cu





Divinski, Herzig, et al Acta Mater (2004)

Bi GB diffusion in Cu

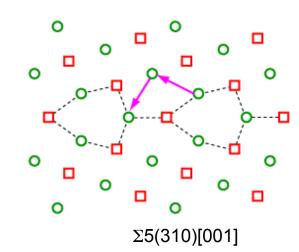


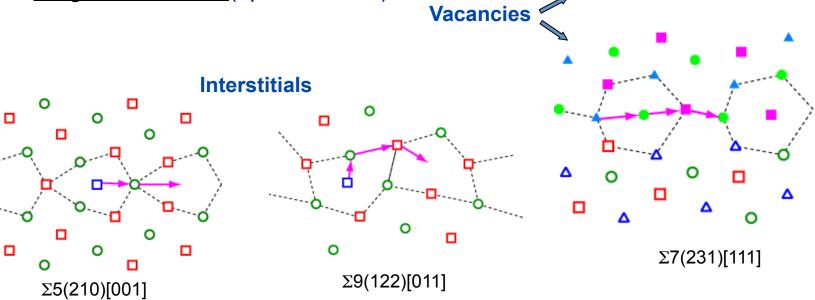
Non-destructive evaluation of GB segregation factors



Diffusion mechanisms in GBs

- Vacancy mechanisms
 - Simple vacancy-atom exchanges
 - Long vacancy jumps (2-3 atoms)
- Interstitial mechanisms
 - Direct jumps
 - Collective jumps (2-4 atoms)
- Ring mechanisms (up to 6 atoms)







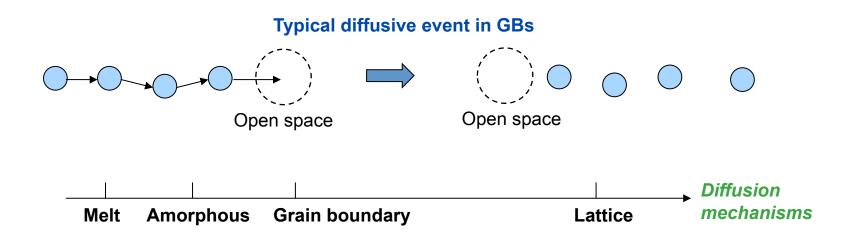
Comparison of GB and lattice diffusion

Lattice diffusion

- Vacancies dominate
- Vacancies move by single-atom exchanges

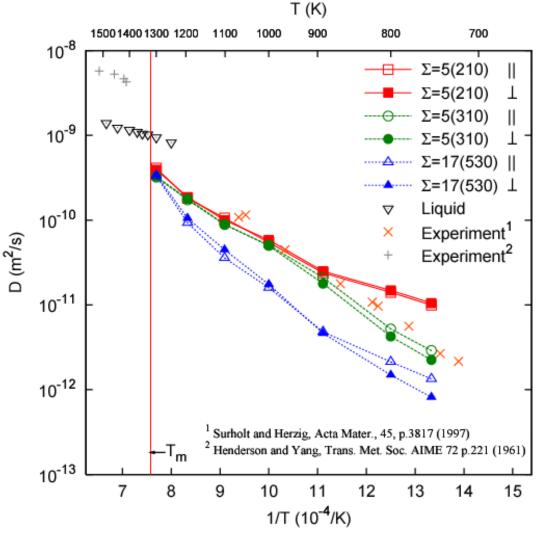
GB diffusion

- Vacancies and interstitials are equally important
- Variety of point-defect structures
- Variety of diffusion mechanisms
- Most diffusive events are collective





GB diffusion in Cu: MD calculations



- Agreement with experiment
- Continuous "premelting" ~100K before T_m
- The Σ5's merge at high temperatures. Universal diffusion mechanism?
 "Liquid-like" structure?
 [Keblinski et al, 1997, 1999]

High-temperature mechanisms remain unknown!

A. Suzuki and Y. Mishin, *Journal of Materials Science* **40**, 3155 (2005)



Diffusion along GBs and triple junctions (TJ) in Cu

Tim Frolov



Triple junction (TJ) is a line where three grain boundaries (GBs) meet together

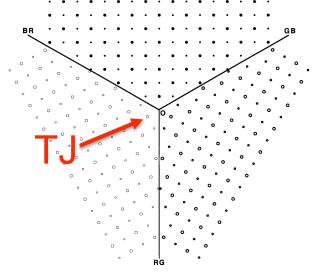


Fig. 1. Electron microphotography (BEI) of sockets for the accelerated penetration Bi in Cu along triple junctions.

 TJs may play a role in behavior of nanocrystalline materials

V.B. Rabukhin et al (1986), B. Bokstein et al (2001)

Enhanced diffusivity of nano-crystalline materials

L.M. Klinger et al (1997), A.A. Fedorov et al (2002), Ovid'ko et al (2004), H. Wang et al (2005) Y. Chen et al (2007)

Plastic deformation

Diffusional creep

Sites of enhanced segregation
 K. M. Yin et al (1997)

- Can limit GB mobility during recrystallization
- Preferable sites of nano-cracks and corrosion
 G. Palumbo et al (1989), W.M. K.

G. Palumbo et al (1989), W.M. Kane et al (2008), L.S. Kumar et al (2003)



Simulation Methodology

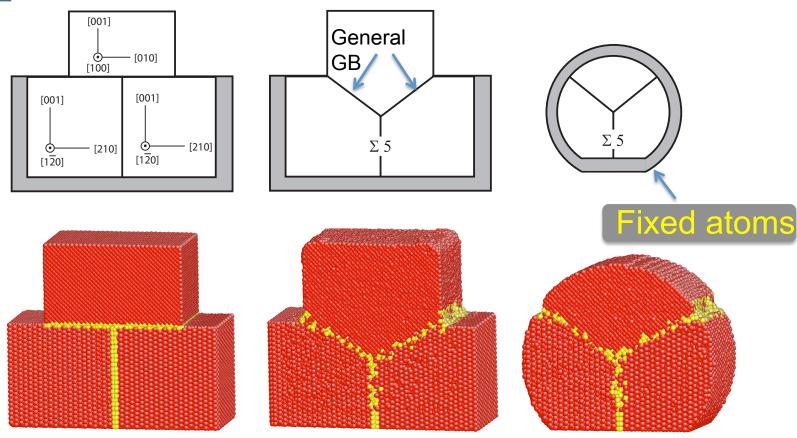
- Copper as a model material
- EAM potential for copper

(lattice parameter, cohesive energy, elastic constants, phonon frequencies, thermal expansion, lattice-defect energies, predicted melting point 1327K)

- Simulation method
 - Molecular Dynamics (MD) (IMD, Stuttgart, Germany)
 - Nose-Hoover thermostat
 - 81,137 atoms
 - Temperature range 700K to 1315K
- Visualization
 - Atomeye (J. Li, Modelling Simul. Mater. Sci. Eng. 11 (2003) 173)



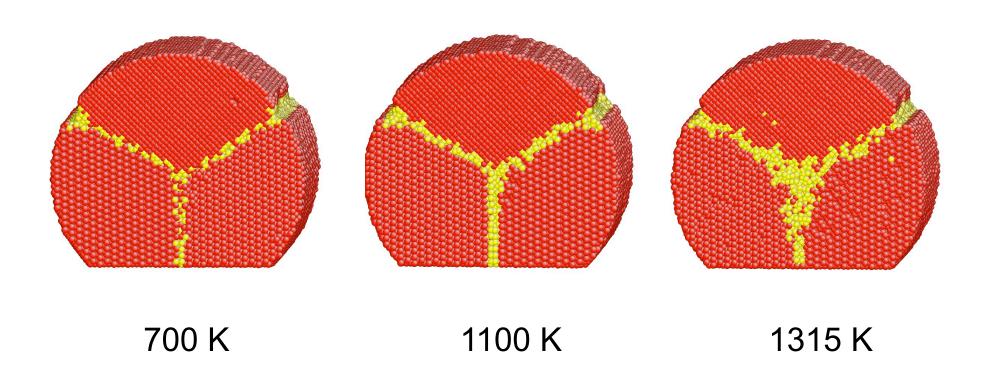
Creation of a triple junction



- Three grains with known orientation are brought together
- The structure equilibrates during MD run
- Cylindrical region is cut out from the original block
- Boundary conditions are periodic in the direction parallel to TJ



Simulation block at different temperatures

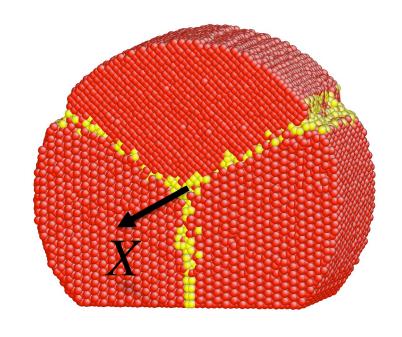


 $T_{\rm m} = 1327 \, {\rm K}$

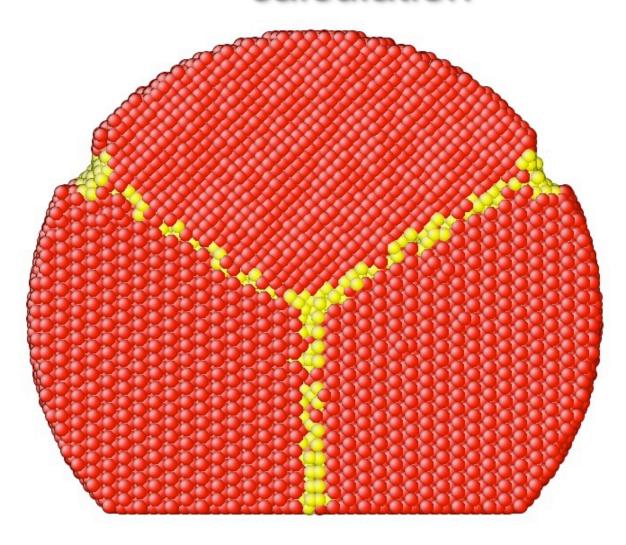


Diffusion calculations

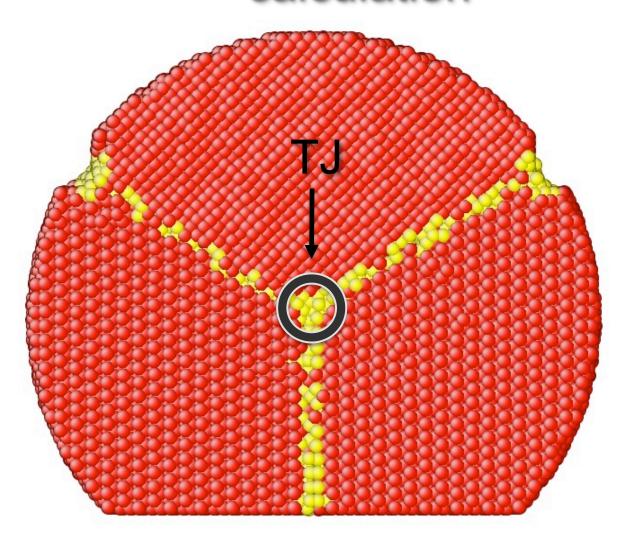
- Einstein relation $\langle X^2 \rangle = 2Dt$
 - X direction parallel to the TJ
 - D diffusion coefficient
 - t time
- Atomic displacements computed for particular regions



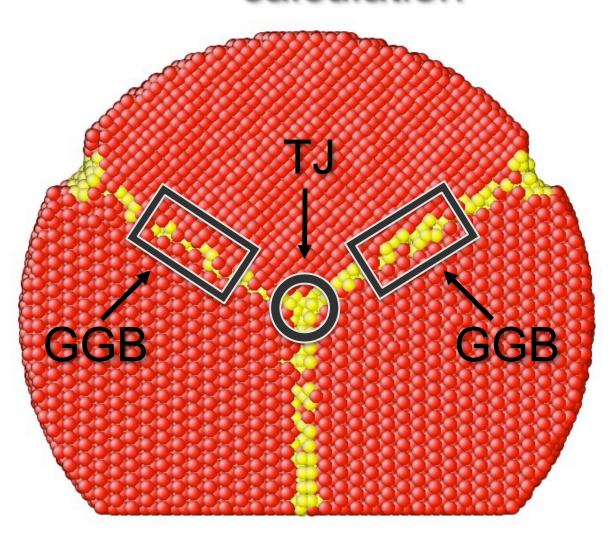




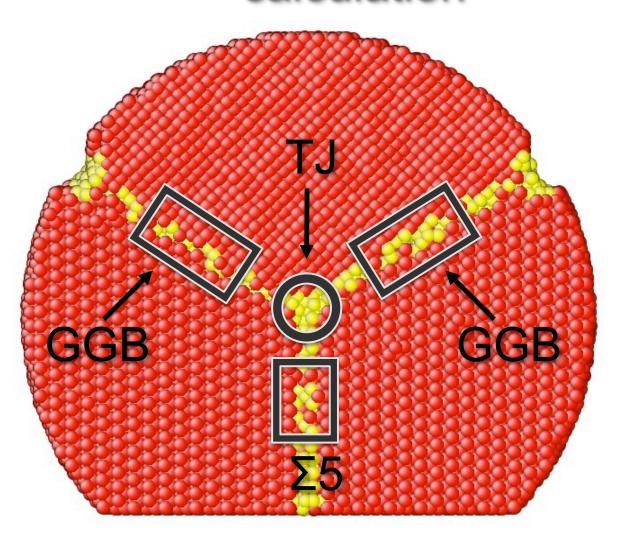














TJ

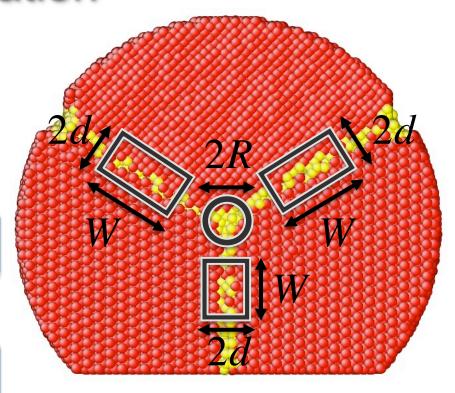
$$2R = 10 \stackrel{o}{A} L = 66 \stackrel{o}{A}$$

Σ5

$$2d = 10\stackrel{o}{A} W = 25\stackrel{o}{A} L = 66\stackrel{o}{A}$$

GGBs

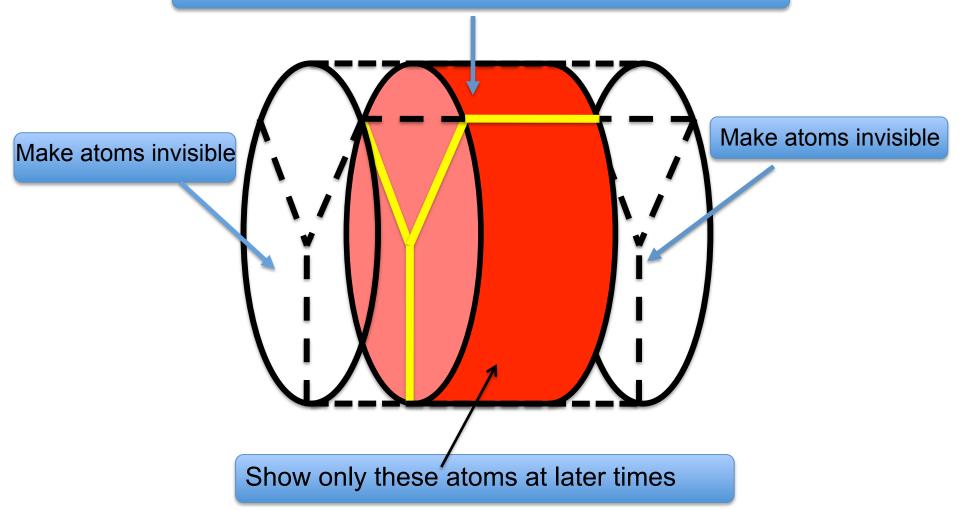
$$2d = 10\stackrel{o}{A} W = 30\stackrel{o}{A} L = 66\stackrel{o}{A}$$



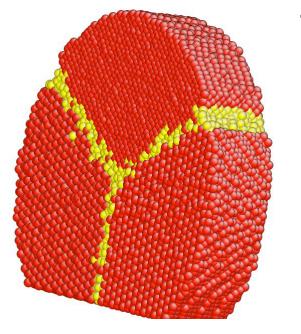


Animation

Select a slab of atoms in the middle of the block



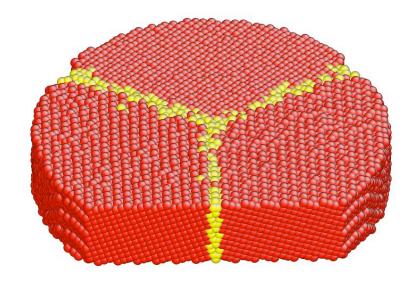


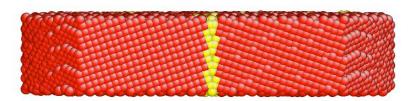


T=1100 K



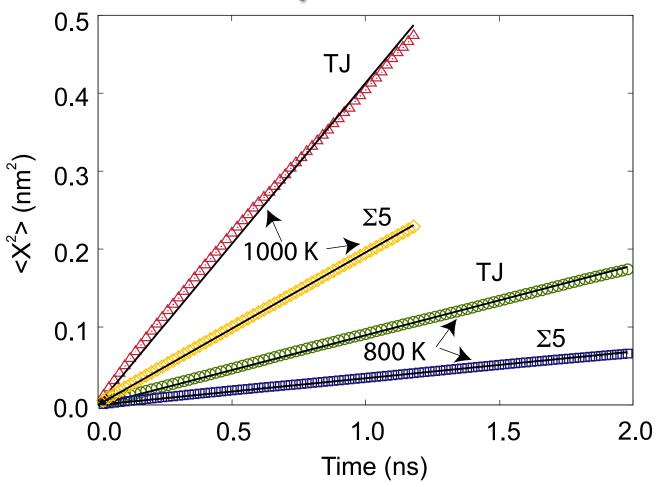
TJ







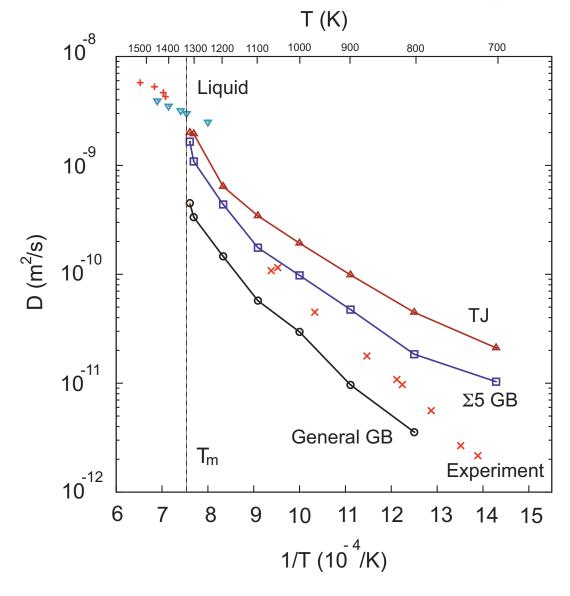
Typical RMS displacement versus time plots for TJ and GBs



Displacements of atoms follow the Einstein relation



Arrhenius diagram of diffusion



- At all T $D_{TJ} > D_{\Sigma 5} > D_{GGB}$
- Premelting at high T
- Experimental data: polycrystalline copper (average over different GBs and TJs)

T. Surholt et al (1997)

liquid copper

J. Henderson et al (1961)



Conclusions

- Stable TJs with controlled crystallographic orientations of the grains can be created in computer simulations
- Self-diffusion in the TJ and adjacent GBs was computed over a range of temperatures
- TJ diffusivity is higher than GB diffusivity at all simulated temperatures
- TJ diffusivity only twice large than the diffusivity in Σ5
 GB
- Contribution of TJs to diffusivity in nano-crystalline materials is probably overestimated



Diffusion along a dislocation grain boundary in Al

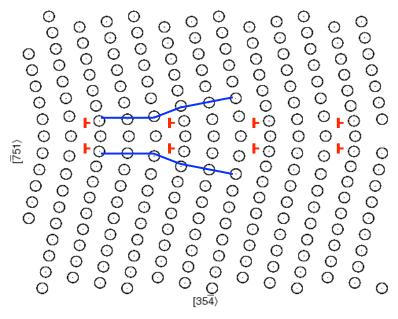
Ganga Pun

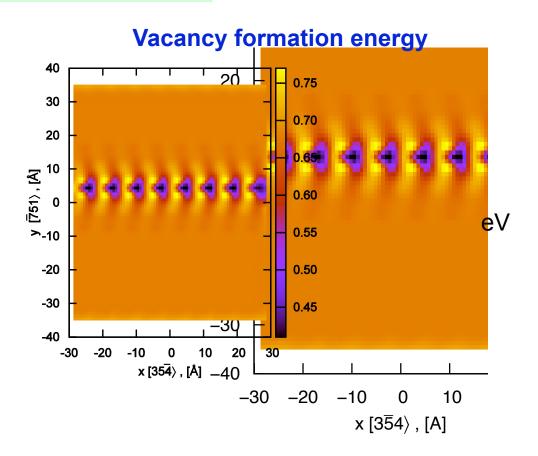


Symmetrical tilt grain boundary in Al

 Σ 75 (751) [112], 23.07°

```
N_{free} = 12,000 \text{ atoms}
L_x = 58.3 \text{Å}
L_y = 107.4 \text{Å}
L_z = 50.4 \text{Å}
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XY view



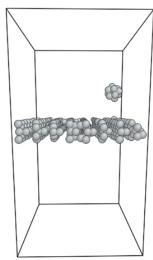
Three types of simulations

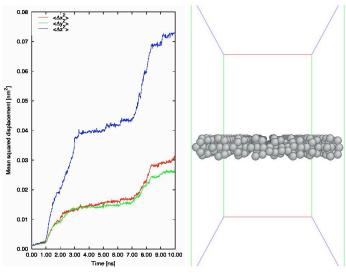
- Pre-existing vacancies
- Pre-existing interstitials
- No pre-existing defect (intrinsic mechanism)



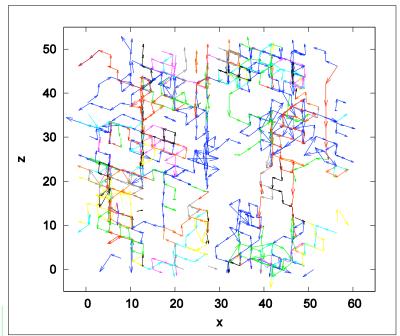
Diffusion along edge dislocations in Σ 75 (751) [112]

800K (w/vacancy)





Atomic jumps: 900K (with 8 vacancies)

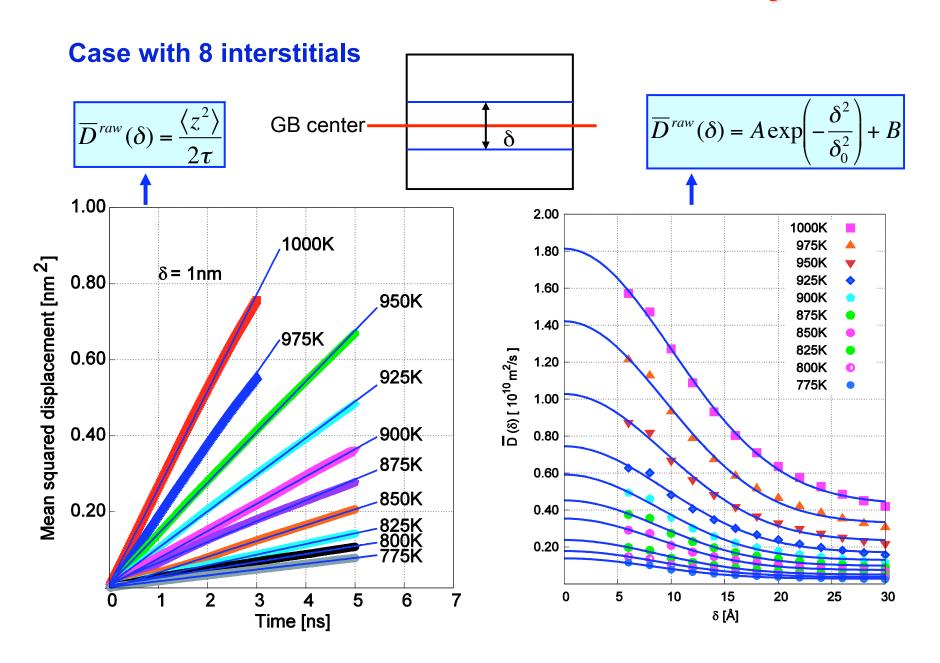


850K (intrinsic)

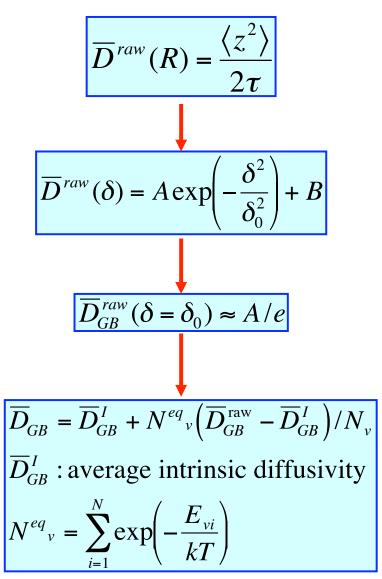
Intrinsic mechanism:

- Frenkel pair forms in the GB
- Vacancy escapes to the lattice
- Interstitial mediates fast diffusion
- The Frenkel pair recombines

Calculation of "raw" diffusivity

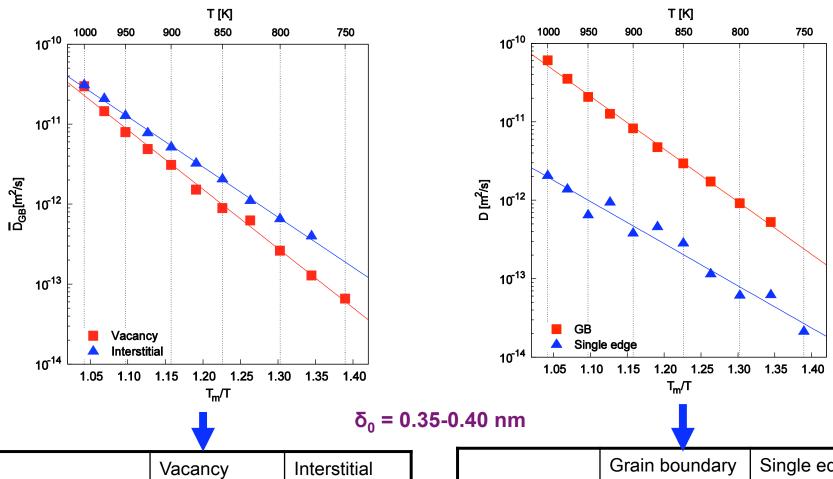


Calculation of actual diffusivity





Arrhenius plots



	Vacancy	Interstitial
E _a (eV)	1.53 ± 0.03	1.30 ± 0.02
$Log(D_0)$ (m ² /s)	-2.91 ± 0.20	-4.00 ± 0.11

	Grain boundary	Single edge
E _a (eV)	1.39 ± 0.02	1.11 ± 0.07
$Log(D_0)$ (m ² /s)	-3.29 ± 0.15	-6.10 ± 0.43



Conclusions

- **Σ** 75 (751) [112], 23.07° symmetrical tilt grain boundary:
 - > Interstitial diffusion dominates over vacancies
 - High diffusivity compared to single edge core
- Working on other low angle symmetrical tilt and twist grain boundaries



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